

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT7892402

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MEDIATEK INC.	12/01/2022
RECEIVING PARTY DATA		
Name:	HFI INNOVATION INC.	
Street Address:	3F.-7, NO.5, TAIYUAN 1ST ST.	
City:	ZHUBEI CITY, HSINCHU COUNTY	
State/Country:	TAIWAN	
Postal Code:	302	
PROPERTY NUMBERS Total: 7		
Property Type	Number	
Patent Number:	10045254	
Patent Number:	10477615	
Patent Number:	9860743	
Patent Number:	9986430	
Patent Number:	10440564	
Patent Number:	10609594	
Patent Number:	10904821	
CORRESPONDENCE DATA		
Fax Number:	(404)521-4286	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	678-483-8899	
Email:	dan.mcclure@mqlaw.com	
Correspondent Name:	MCCLURE, QUALEY & RODACK LLP	
Address Line 1:	280 INTERSTATE NORTH CIRCLE	
Address Line 2:	SUITE 530	
Address Line 4:	ATLANTA, GEORGIA 30339	
ATTORNEY DOCKET NUMBER:	250848-9030	
NAME OF SUBMITTER:	DANIEL R. MCCLURE	
SIGNATURE:	/Daniel R. McClure/	
DATE SIGNED:	04/10/2023	

PATENT

Total Attachments: 11

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PATENT ASSIGNMENT AGREEMENT

This Patent Assignment Agreement (“Agreement”) is made as of December 1, 2022 (the “Effective Date”) by MediaTek Inc., a Taiwanese corporation having a place of business at No. 1 Dusing 1 Rd., Hsinchu Science Park, Hsinchu, Taiwan (“**Assignor**”), to HFI Innovation Inc., a Taiwanese corporation having a place of business at 3F.-7, No.5, Taiyuan 1st St., Zhubei City, Hsinchu County 302, Taiwan (R.O.C.) (“**Assignee**”).

WHEREAS Assignor owns the patent(s) (“**Patents**”) and patent applications (“**Patent Applications**”) set forth in Exhibit A hereto; and

WHEREAS Assignee desires to acquire Assignor’s entire right, title and interest in and to the Patents, Patent Applications, and the Future Patents (as hereinafter defined);

NOW, THEREFORE, in consideration of mutual covenants and agreements set forth below, and for other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the parties hereto agree as follows:

1. **ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS.** Assignor hereby irrevocably and unconditionally grants, conveys, transfers, and assigns to Assignee all of Assignor’s right, title and interest in and to the Patents, the Patent Applications, the inventions disclosed therein, and all future patents that may issue from Patent Applications throughout the world, and all foreign counterparts, divisionals, continuations in whole or in part, reexaminations, reissues, substitutions or extensions of any of the preceding (collectively “**Future Patents**”), and the right to claim priority to any of the preceding, the same to be held by Assignee for Assignee’s own use and enjoyment, and for the use and enjoyment of Assignee’s successors, assigns and other legal representatives, together with all claims for injunctive relief and damages by reason of past, present and future infringements of the Patents and Future Patents and the *sole* right to sue for and collect such damages or seek such injunctive relief, as permitted under the applicable laws for any jurisdiction or country in which such claims may be asserted. *With respect to the sole right to sue assigned and transferred to Assignee, Assignor hereby expressly disclaims any and all rights to sue or otherwise enforce such Patents.*

2. **PAYMENT.** As consideration for the assignment under this Agreement, Assignee shall convey to Assignor the amount of [REDACTED]

a) [REDACTED]



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[REDACTED]
[REDACTED]

b) [REDACTED]
[REDACTED]
[REDACTED]

[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]

[REDACTED]
[REDACTED]
[REDACTED]

[REDACTED]
[REDACTED]

[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]

[REDACTED]
[REDACTED]
[REDACTED]
[REDACTED]

3. **ISSUANCE OF FUTURE PATENTS.** Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks Offices of the United States, and any officer of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of intellectual property protection or applications as aforesaid, to issue the Future Patents to Assignee and its successors, assigns and other legal representatives in accordance with the terms of this instrument.



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4. **ASSISTANCE.** Assignor agrees to perform, without charge to Assignee (except as otherwise permitted herein), all acts deemed necessary or desirable by Assignee to permit and assist Assignee in perfecting and procuring the full benefits, enjoyment, rights, title and interest throughout the world in all Patents, Patent Applications and Future Patents, and the intellectual property rights therein assigned to Assignee hereunder. Such acts may include execution of documents, including any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith, assistance and cooperation in the registration of applicable intellectual property rights. [REDACTED]

5. **POWER OF ATTORNEY.** [REDACTED]

6. **DELIVERY.** [REDACTED]

7. **REPRESENTATIONS AND WARRANTIES.** Assignor represents and warrants that: (i) Assignor has full right, power, and authority to enter into this Agreement and to perform its obligations and duties under this Agreement, and that the performance of such obligations and duties does not and will not conflict with or result in a breach of any other agreements to which Assignor is a party or any judgment, order, or decree by which Assignor is bound; and (ii) Assignor owns all right, title, and interest in and to the Patents and Patent Applications, free and clear of any security interest, option, lien, license, or encumbrance of any nature.

8. **GENERAL.**



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A. Notice.

[REDACTED]

[REDACTED]	[REDACTED]
[REDACTED]	[REDACTED]
[REDACTED]	[REDACTED]
[REDACTED]	[REDACTED]

B. Governing Law.

[REDACTED]

C. Remedies.

[REDACTED]

D. Waiver.

[REDACTED]

E. Severability.

[REDACTED]

F. Independent Contractors.

[REDACTED]

G. Construction.

[REDACTED]

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[REDACTED]
[REDACTED]
H. Counterparts. [REDACTED]
[REDACTED]
[REDACTED]

I. Entire Agreement. This Agreement, including the Exhibit A, sets forth the entire understanding of the parties relating to the subject matter hereof and supersedes all prior agreements and understandings between the parties relating to the subject matter hereof. This Agreement may not be amended, modified, altered, or supplemented other than by means of a written instrument duly executed and delivered on behalf of both parties.

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IN WITNESS WHEREOF, the parties have executed this Agreement on the date first above written.

Assignor:

MediaTek Inc.

By: 

Name: David Su

Title: Corporate Vice President and General Counsel

Assignee:

HFI Innovation Inc.

By: 

Name: David Ku

Title: Director

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EXHIBIT A

PATENTS AND PATENT APPLICATIONS

(PLEASE SEE ATTACHED)

	Invention Reference	Patent Reference	Patent No.	Application Number	Country	Status
6	MTKI-15-0162	MTKI-15-0162PCT-EP-GB	3195649	16737056.8	United Kingdom	Granted
9	MTKI-15-0162	MTKI-15-0162US	10,045,254	14/989,101	United States of America	Granted
10	MTKI-15-0162	MTKI-15-0162US-1	10,609,594	15/971,263	United States of America	Granted

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